

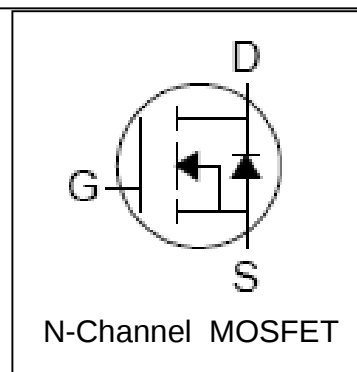
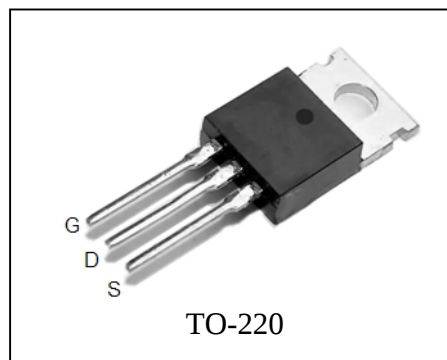
Features

- 30V/290A,
 $R_{DS(ON)} = 1.8m\Omega(Typ.) @ V_{GS}=10V$
- Super High Dense Cell Design
- Ultra Low On-Resistance
- 100% avalanche tested
- Lead Free and Green Devices Available
(RoHS Compliant)

Applications

- DC-DC Converters and Off-line UPS
- Switching Applications

Pin Description



Absolute Maximum Ratings

Symbol	Parameter		Rating	Unit
Common Ratings (T _C =25°C Unless Otherwise Noted)				
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	
T _J	Maximum Junction Temperature		175	°C
T _{STG}	Storage Temperature Range		-55 to 175	°C
I _S	Diode Continuous Forward Current	T _C =25°C	290 ^①	A
Mounted on Large Heat Sink				
I _{DP}	300μs Pulse Drain Current Tested	T _C =25°C	1160 ^②	A
I _D	Continuous Drain Current(V _{GS} =10V)	T _C =25°C	290 ^①	A
		T _C =100°C	194 ^①	
P _D	Maximum Power Dissipation	T _C =25°C	375	W
		T _C =100°C	188	W
R _{θJC}	Thermal Resistance-Junction to Case		0.4	°C/W
Drain-Source Avalanche Ratings				
E _{AS} ^③	Avalanche Energy, Single Pulsed		306	mJ

Electrical Characteristics (T_C=25°C Unless Otherwise Noted)

Symbol	Parameter	Test Condition	RU30290R			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	μA
		T _J =85°C			30	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	2		4	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
R _{DS(ON)} ^④	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =75A		1.8	2.5	mΩ
Diode Characteristics						
V _{SD} ^④	Diode Forward Voltage	I _{SD} =75A, V _{GS} =0V			1.2	V
t _{rr}	Reverse Recovery Time	I _{SD} =75A, dI _{SD} /dt=100A/μs		56		ns
Q _{rr}	Reverse Recovery Charge			102		nC
Dynamic Characteristics ^⑤						
R _G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz		1.5		Ω
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, Frequency=1.0MHz		4950		pF
C _{oss}	Output Capacitance			1010		
C _{rss}	Reverse Transfer Capacitance			210		
t _{d(ON)}	Turn-on Delay Time	V _{DD} =15V, R _L =0.2Ω I _{DS} =75A, V _{GEN} =10V, R _G =2.5Ω		21		ns
t _r	Turn-on Rise Time			99		
t _{d(OFF)}	Turn-off Delay Time			105		
t _f	Turn-off Fall Time			52		
Gate Charge Characteristics ^⑤						
Q _g	Total Gate Charge	V _{DS} =24V, V _{GS} =10V, I _{DS} =75A		95		nC
Q _{gs}	Gate-Source Charge			27		
Q _{gd}	Gate-Drain Charge			32		

Notes: ① Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.

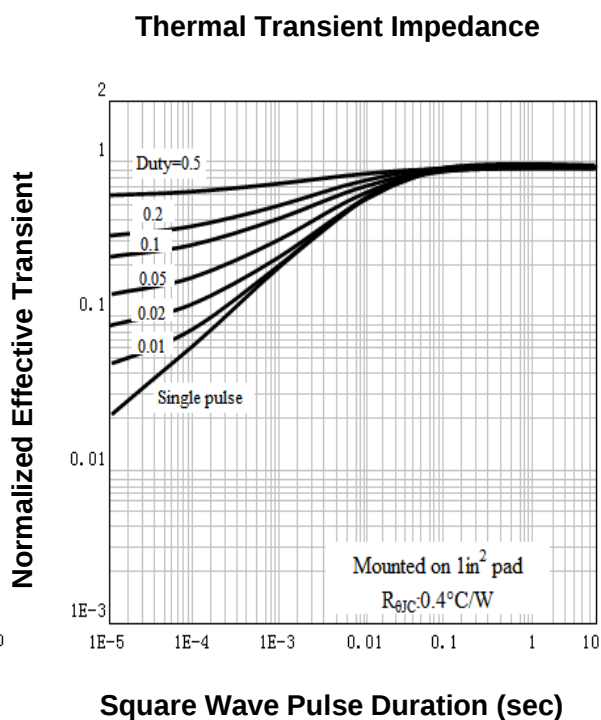
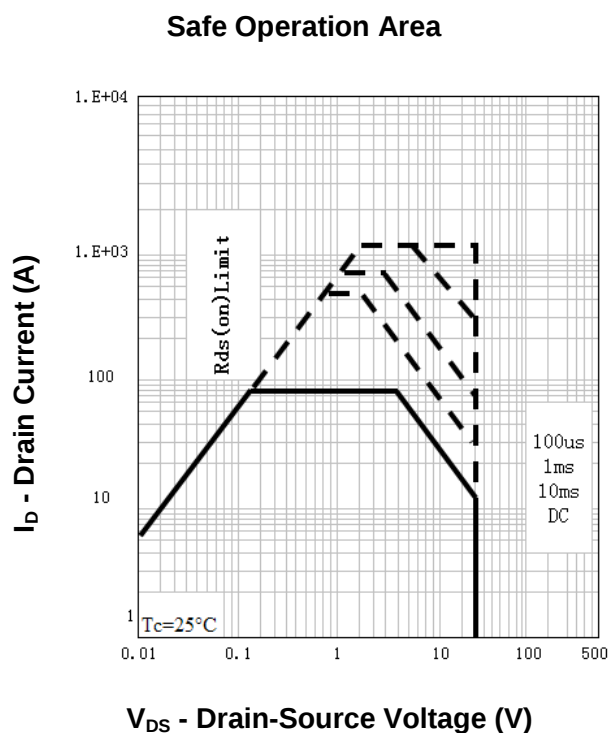
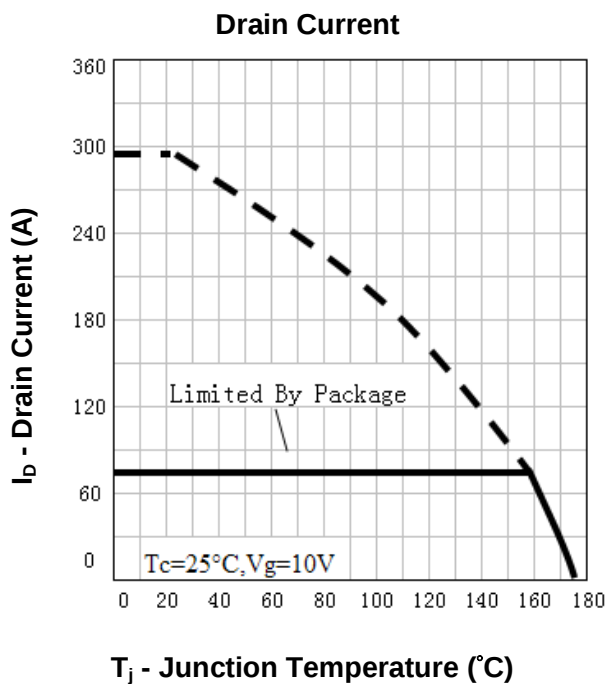
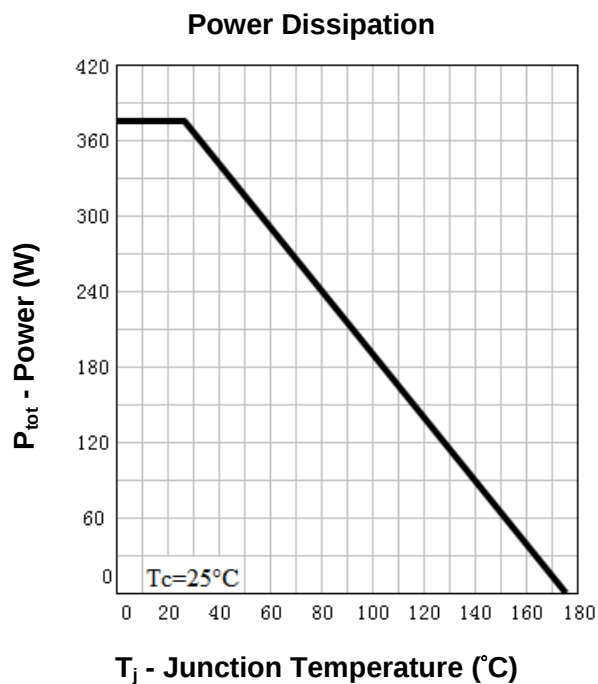
② Pulse width limited by safe operating area.

③ Limited by T_{Jmax}, I_{AS} = 35A, V_{DD} = 24V, R_G = 50Ω, Starting T_J = 25°C.

④ Pulse test; Pulse width ≤ 300μs, duty cycle ≤ 2%.

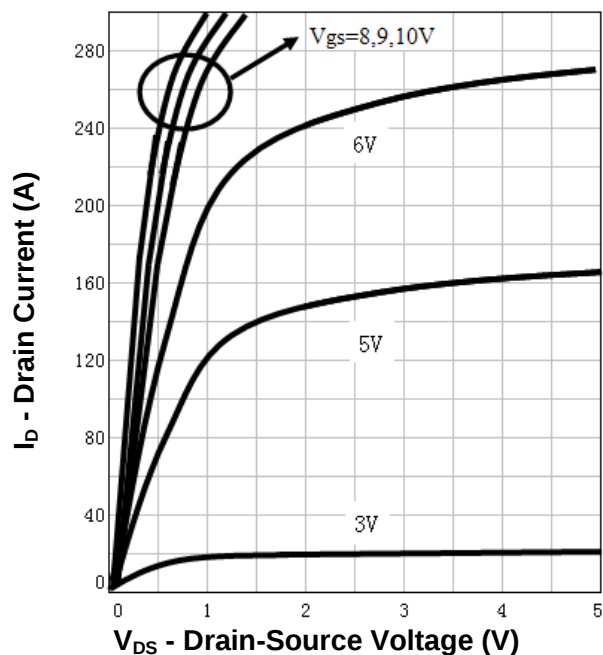
⑤ Guaranteed by design, not subject to production testing.

Typical Characteristics

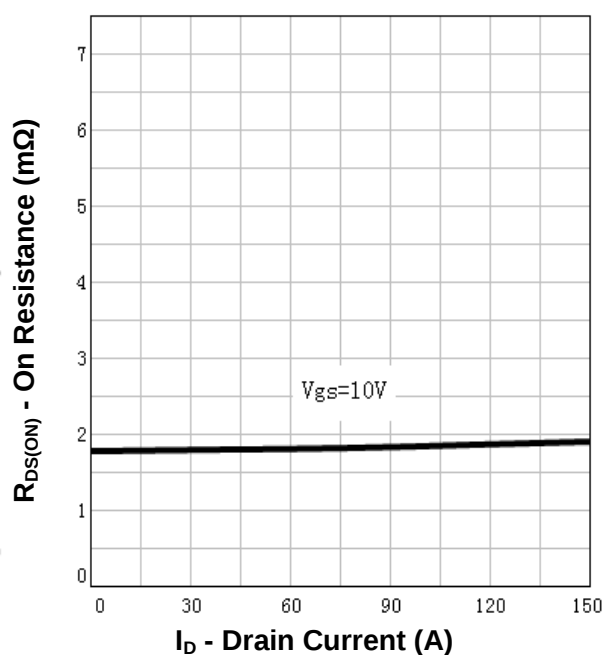


Typical Characteristics

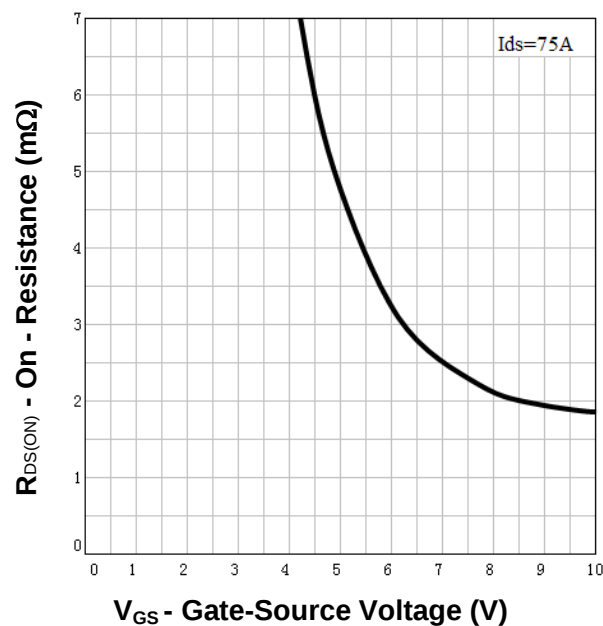
Output Characteristics



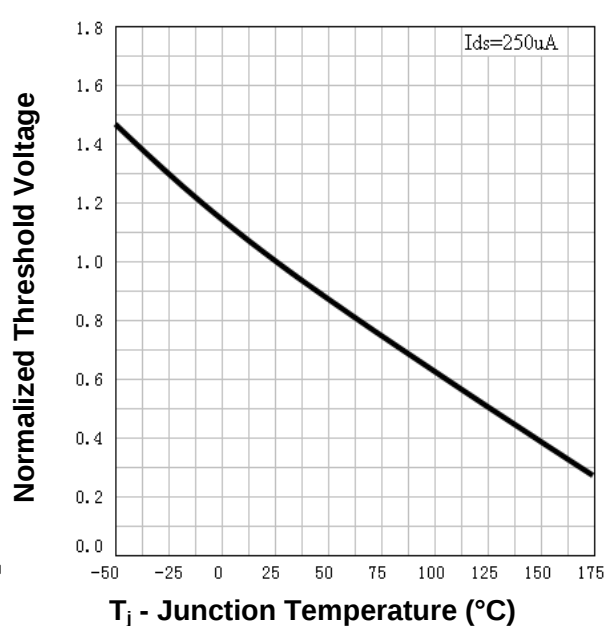
Drain-Source On Resistance



Drain-Source On Resistance

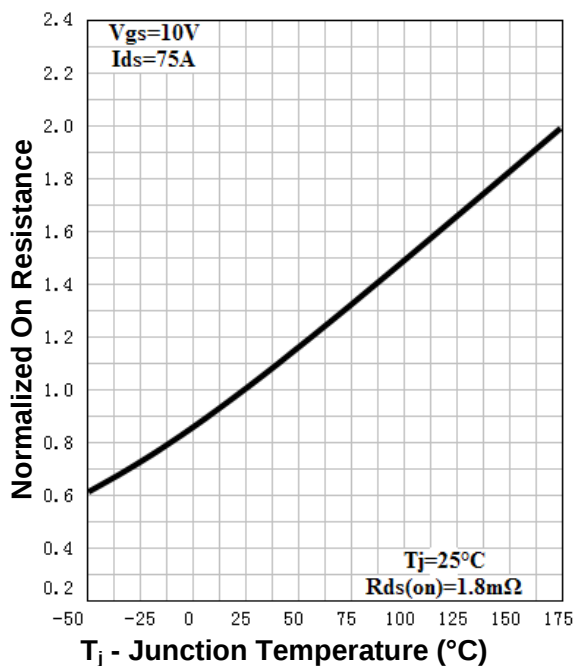


Gate Threshold Voltage

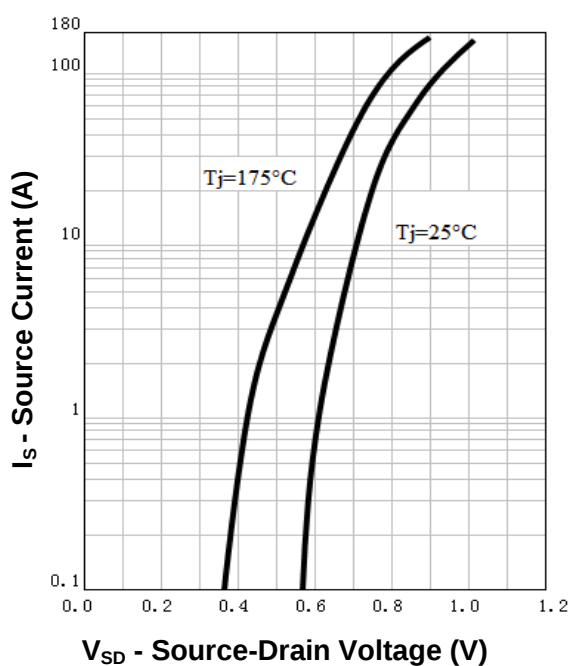


Typical Characteristics

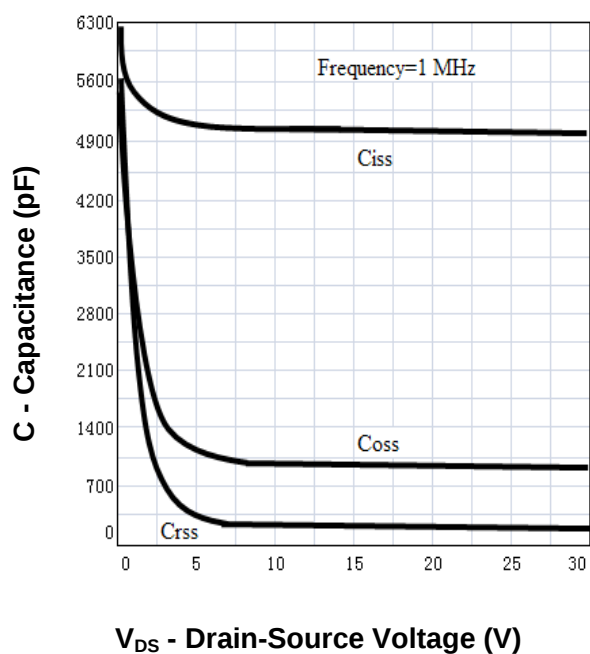
Drain-Source On Resistance



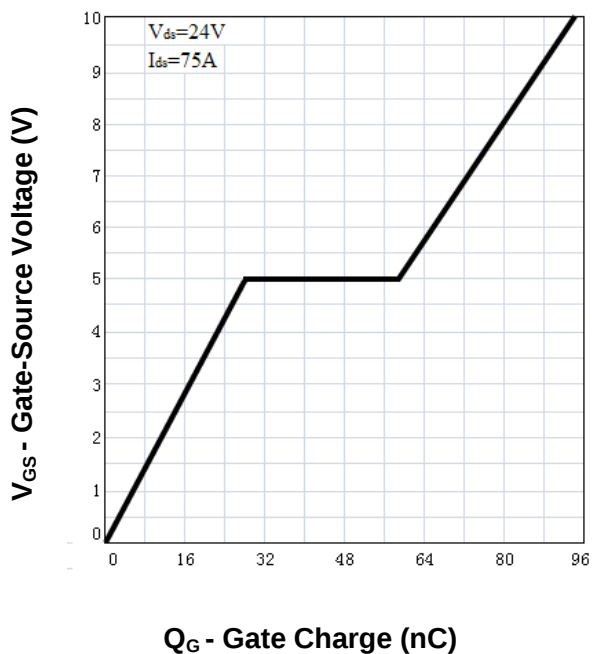
Source-Drain Diode Forward



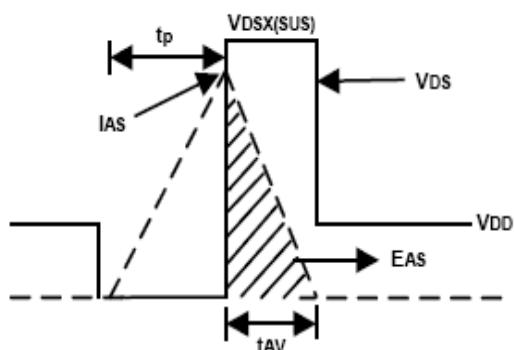
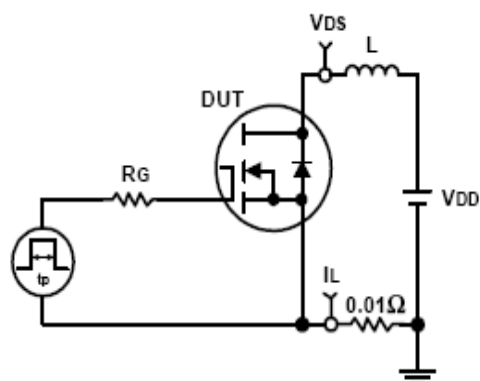
Capacitance



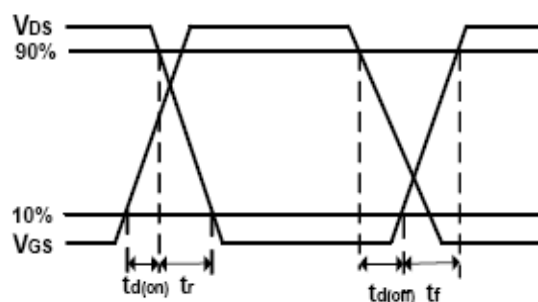
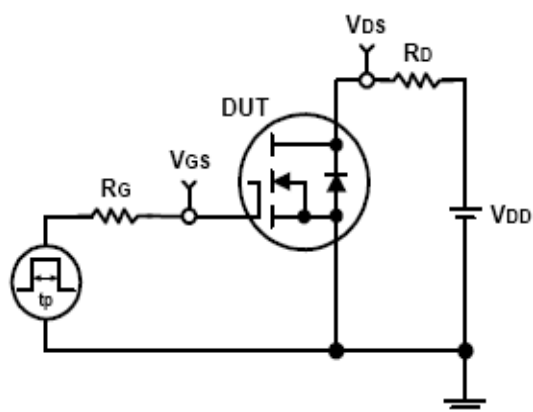
Gate Charge



Avalanche Test Circuit and Waveforms



Switching Time Test Circuit and Waveforms

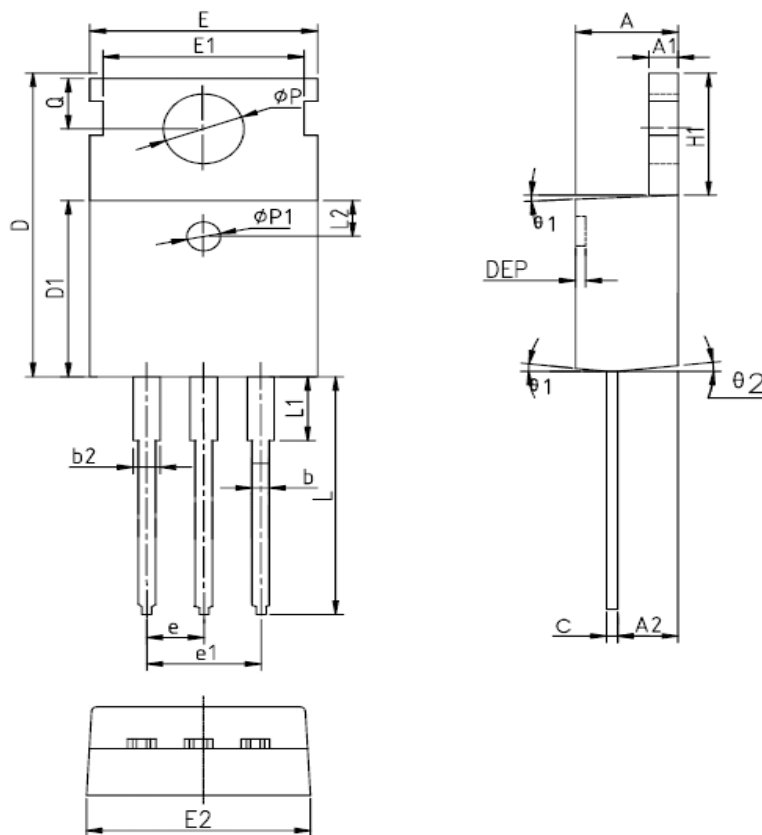


Ordering and Marking Information

Device	Marking	Package	Packaging	Quantity	Reel Size	Tape width
RU30290R	RU30290R	TO-220	Tube	50	-	-

Package Information

TO-220FB-3L



SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	4.40	4.57	4.70	0.173	0.180	0.185	$\phi p1$	1.40	1.50	1.60	0.055	0.059	0.063
A1	1.27	1.30	1.33	0.050	0.051	0.052	e	2.54BSC			0.1BSC		
A2	2.35	2.40	2.50	0.093	0.094	0.098	e1	5.08BSC			0.2BSC		
b	0.77	-	0.90	0.030	-	0.035	H1	6.40	6.50	6.60	0.252	0.256	0.260
b2	1.23	-	1.36	0.048	-	0.054	L	12.75	-	13.17	0.502	-	0.519
C	0.48	0.50	0.52	0.019	0.020	0.021	L1	-	-	3.95	-	-	0.156
D	15.40	15.60	15.80	0.606	0.614	0.622	L2	2.50REF.			0.098REF.		
D1	9.00	9.10	9.20	0.354	0.358	0.362	ϕp	3.57	3.60	3.63	0.141	0.142	0.143
DEP	0.05	0.10	0.20	0.002	0.004	0.008	Q	2.73	2.80	2.87	0.107	0.110	0.113
E	9.70	9.90	10.10	0.382	0.389	0.398	$\theta 1$	5°	7°	9°	5°	7°	9°
E1	-	8.70	-	-	0.343	-	$\theta 2$	1°	3°	5°	1°	3°	5°
E2	9.80	10.00	10.20	0.386	0.394	0.401							

ALL DIMENSIONS REFER TO JEDEC STANDARD
DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS

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